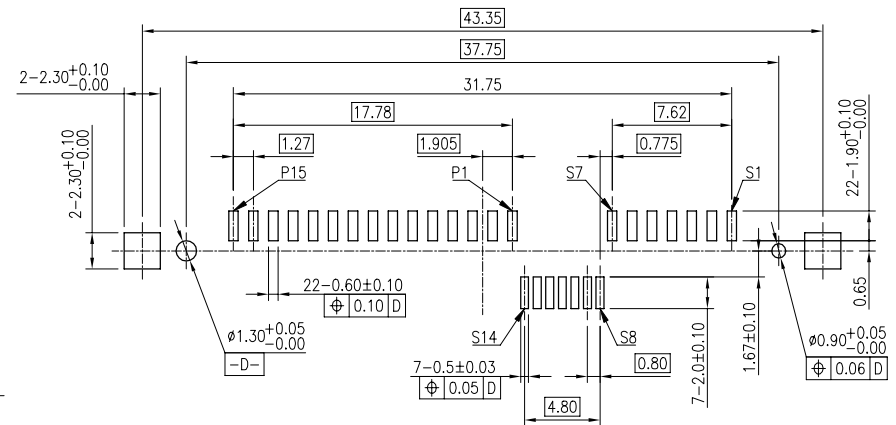


NOTES:

1. MATERIAL:
  - 1.1 HOUSING: THERMOPLASTIC, HIGH TEMP.,UL94V-0; COLOR:BLACK.
  - 1.2 CONTACT: COPPER ALLOY
  - 1.3 FIT NAIL: COPPER ALLOY
2. FINISH:
  - 2.1 CONTACT:
    - 100~200u" MATTE TIN PLATING ON SOLDER TAILS.
    - 50~100u" NICKEL UNDERPLATING OVERALL.
    - (D) 30u" GOLD PLATING ON CONTACT AREA.
  - 2.2 FIT NAIL:
    - 100~200u" MATTE TIN PLATING ON SOLDER TAILS.
    - 50~100u" NICKEL UNDERPLATING OVERALL.
3. REFLOW SOLDER CAPABLE TO 260°C ,PER ACES SPEC.
4. SPEC. PLS. REFER TO PS-51902-XXXX-XXX
5. PACKAGE PLS. REFER TO 51902-XXXX-XX-TRP
6. SUPPORT FOR SAS4
7. PART NUMBER
 

51902-029 X X-XXX	
NO OF CKT	TYPE
XXX.CKT	001: NONE
PLATING	
Packing	D: 30u" GOLD PLATING ON CONTACT AREA
O: TAPE&REEL	



RECOMMENDED P.C.B. LAYOUT

<b>QUALITY SYMBOLS</b> MAJOR Ⓢ CRITICAL Ⓢ <b>GENERAL TOLERANCES (UNLESS SPECIFIED)</b> X ± 0.5 X ± 0.25 .XX ± 0.15 .XXX ± 0.1 ANGLES ± 2°	DRAWN BY Huang, Wen Ying 22/05/24	DATE 22/05/24	
	CHECKED BY Lee, I Hung 22/05/24	DATE 22/05/24	
	APPROVED BY Wang, Chun Sheng 22/05/24	DATE 22/05/24	UNITS mm
	SCALE 2 : 1	SHEET NO. 1 OF 1	SIZE A4 RFRQ NO. N/A
			REV A DWG NO. 51902-029XX-XXX